Very fast hot carrier diffusion in unconstrained MoS$_2$ on a glass substrate: discovered by picosecond ET-Raman†

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The currently reported optical-phonon-scattering-limited carrier mobility of MoS$_2$ is up to 417 cm$^2$ V$^{-1}$ s$^{-1}$ with two-side dielectric screening: one normal-$k$ side and one high-$k$ side. Herein, using picosecond energy transport state-resolved Raman (ET-Raman), we demonstrated very fast hot carrier diffusion in µm-scale (lateral) unconstrained MoS$_2$ (1.8–18 nm thick) on a glass substrate; this method enables only one-side normal-$k$ dielectric screening. The ET-Raman method directly probes the diffusion of the hot carrier and its contribution to phonon transfer without contact and additional sample preparation and provides unprecedented insight into the intrinsic $D$ of MoS$_2$. The measured $D$ values span from 0.76 to 9.7 cm$^{-1}$ s$^{-1}$. A nonmonotonic thickness-dependent $D$ trend is discovered, and it peaks at 3.0 nm thickness. This explains by the competition between two physical phenomena: with an increase in sample thickness, the increased screening of the substrate results in higher mobility; moreover, thicker samples are subject to more surface contamination, loose substrate contact and weaker substrate dielectric screening. The corresponding carrier mobility varies from 31.0 to 388.5 cm$^2$ V$^{-1}$ s$^{-1}$. This mobility is surprisingly high considering the normal-$k$ and single side dielectric screening by the glass substrate. This is a direct result of the less-damaged structure of MoS$_2$ that is superior to those of MoS$_2$ samples reported in literature studies that are subjected to various post-processing techniques to facilitate measurement. The very high hot carrier mobility reduces the local carrier concentration and enhances the Raman signal, which is further confirmed by our Raman signal studies and comparison with theoretical studies.

Introduction

Two-dimensional (2D) layered transition metal dichalcogenides (TMDs) have attracted significant research attention due to their potential applications in electronic and optical devices. Among TMDs, molybdenum disulfide (MoS$_2$) is one of the most stable layered materials of this class. The thickness-dependent bandgap of MoS$_2$ (1.3–1.8 eV) endows it with a broad range of diverse applications; especially, coating a silicon-based solar cell with the MoS$_2$ film can greatly improve the efficiency of the cell. Additionally, MoS$_2$-based field-effect transistors (FETs) have demonstrated very promising electronic characteristics such as high current on/off ratios ($10^5$–$10^{10}$) and carrier mobilities (up to 410 cm$^2$ V$^{-1}$ s$^{-1}$). With the rapidly increasing interest in the development of MoS$_2$-based devices, determination of the intrinsic properties and the interface thermal energy coupling of MoS$_2$ is of primary significance.

The interface thermal energy coupling of devices is a critical property because it determines their overall performance and lifetime. However, accurate and straightforward measurement of this property is still very challenging due to the involvement of many different complicated physical phenomena. Both theoretical and experiment-based methods have been developed and successfully applied to characterize interface thermal energy coupling. Theoretical studies use the acoustic/diffuse mismatch model and molecular dynamics simulations. Experiment-based methods include the pump-probe technique and Raman-based thermal probing technique. Additionally, for semiconductor materials under an electrical field or light excitation, the generated hot carriers can significantly contribute to thermal diffusion in electronic devices. Similar to free electrons in metals, hot carriers can diffuse in semiconductor materials; therefore, their movement is strongly affected by various interactions between...
the carriers and other excitations. By studying hot carrier diffusion, we can obtain a deeper understanding of the scattering process and energy distribution in semiconductors. For MoS2, most work has focused on measuring its mobility, in which the carrier is generated under an electric field and the sample is covered by a top-gate or connected to the electric contact to form FETs. However, these treatments are still believed to provide inaccurate or overestimated results. One possible reason is that the sample may be modified during the device preparation process. Therefore, by studying carrier transport without applying an electric field and with proper use of a dielectric substrate, the intrinsic properties of MoS2 nanosheets can be obtained. Accordingly, optical-based measurements of the transport properties of hot carriers are preferred, such as transient absorption microscopy, spatially and temporally resolved pump-probe techniques, and Raman-based techniques.

Currently, silicon wafer is a very popular substrate for standard integrated circuit processing; it is ideal for creating transistors due to its extreme uniformity and good chemical and mechanical strength. Therefore, tremendous work has focused on the study of semiconductor materials supported on silicon substrates, such as graphene, TMDs, and black phosphorus. However, in other applications, such as display pixel backplanes and peripheral logic devices, glass or plastic substrates are more recommended. For MoS2 supported on glass substrates, a few related studies have been reported; however, these are limited to simple FET structures. From another aspect, the mechanical properties of MoS2 nanosheets can be strongly affected by the properties and morphology of the substrate. Unlike the polished c-Si substrate we used in our previous work, MoS2 prepared through mechanical exfoliation onto a glass substrate does not follow its nanoscale rough surface but instead is supported by the high points on the substrate. This surface roughness affects the energy coupling of MoS2 nanosheets and the substrate; therefore, it may cause a local variance in the electrical and mechanical properties of a sample. Tang et al. indicated that loose contact at an interface can significantly increase the thermal resistance of the interface. Also, a large temperature increase in glass substrates is expected in experiments due to its relatively low thermal conductivity. However, the temperature profiles of glass substrates cannot be obtained by Raman spectroscopy because there is no prominent Raman spectrum in most glass substrates. Additionally, compared with c-Si substrate, the greater dielectric effect from the glass substrate (SiO2) can dramatically increase the carrier diffusion coefficient of its supported MoS2 nanosheets. Due to these additional considerations when using glass instead of Si as a substrate, it is very challenging and complicated to study MoS2 nanosheets supported on glass substrates.

Here, before reporting our current work, we would like to outline the significant advances we reported in each of our three previous studies published on 2D MoS2 to demonstrate the significance and discovery of the current work. In the first study, for the first time, we reported the dependence of the thermal resistance/conductance of the MoS2/c-Si interface on the thickness of the 2D nanofilm and provided a rigorous analysis of the effects of Si laser absorption on the interface structure. Later during our extensive study, as reported in the second publication, we discovered that hot carrier generation, diffusion, and recombination can play vital roles in in-plane and cross-plane energy transfer in the MoS2/c-Si interface system. Furthermore, the effects of hot carrier diffusion on interface thermal energy transport had rarely been studied. Therefore, we designed a novel technique and a new physical model to characterize hot carrier diffusion and thermal transport at the MoS2/c-Si interface. This is the first consideration of this conjugated transfer and represented the most advanced study at that time. In the above two studies, the optical properties of the materials are need-to-know parameters to evaluate the laser absorption rates. This evaluation can induce considerable uncertainties and unknown errors due to variation between samples and interface optical interference. Additionally, it is necessary to obtain the Raman wavenumber temperature coefficient to evaluate the absolute temperature increase of a sample. This results in very large errors, as reported for all previous Raman-based measurements. In fact, studies on MoS2 interface thermal resistance by different groups worldwide have reported results with substantial deviations which cannot be simply explained by differences in sample structure. Therefore, we developed an entirely new technique independent of laser-absorption evaluation and Raman-temperature calibration to provide the most accurate characterization to date. This was reported in our third study, where an energy transport state-resolved Raman (ET-Raman) technique was developed using CW and picosecond Raman with consideration of both in-plane hot carrier diffusion and interface energy coupling. This is the best Raman-based technique to date to characterize 2D material energy transfer. We expect that this technique will have a long-term profound impact, like the pump-probe technique, in characterizing thermal and charge carrier transfer in extremely thin structures. The reason that we are still using MoS2/c-Si is to compare our results with previous results for both technique verification and uncertainty analysis.

In this work, the advanced ET-Raman technique is applied to study six mechanically exfoliated MoS2 nanosheet samples (thickness from 1.8 nm to 18 nm) supported on glass substrate. We discovered high-end hot carrier diffusivity which is comparable to that of MoS2 sandwiched between very high-κ dielectric materials. Considering the low-κ glass substrate and its single-side dielectric screening, our reported high-end hot carrier diffusion is unexpectedly high and has never been reported before. Furthermore, variation of the nonmonotonic hot carrier diffusivity with MoS2 thickness is revealed and explained by the different physical phenomena affecting the diffusivity. This indicates new methods of fabricating novel MoS2-based devices with high mobility via control of the substrate type and sample thickness. For substrate materials with low thermal conductivity (e.g. the glass used in this work), our originally developed ET-Raman technique has been re-designed to include two picosecond laser heating states and to use their differential to rule out long-term heat accumulation and
unknown thermal response of the substrate because no Raman signals are provided.

**Physical principles of picosecond ET-Raman**

In ET-Raman, different energy transport states are constructed in both space and time domains to examine the thermal response of a sample. Fig. 1(a) shows the physical principles of this technique. Hot carriers will be generated when the photon energy is larger than the bandgap of MoS$_2$. With additional energy $\Delta E = (E - E_g)$, the hot carriers (electrons) are unstable and will lose energy by a fast thermalization process (~0.5 to 1 ps). Then, the remaining photon energy ($E_g$) will be carried by the carriers. They take this energy and diffuse out of the excitation area until they recombine with holes to release the energy to local phonons. Therefore, the real heating area will be expanded due to the hot carrier diffusion. By using Raman spectroscopy, we can probe the different temperature profiles of a sample. Note that for glass substrates, no hot carriers are generated and the surface recombination of MoS$_2$ will be strongly restricted due to the dielectric effect of the substrate. The energy of the phonons in the MoS$_2$ nanosheets will dissipate within the sample and through the layers down to the glass substrate to increase the local temperature.

We generated two sub-states for steady-state heating with different laser heating sizes. As shown in Fig. 1(c) and (d), we used a CW laser source to study the temperature profile with only the $(R, D)$ effects. Different objective lenses (100× and 20×) were used to differentiate the effects of $D$ and $R$. The laser spots have radii of 1.50 μm and 0.366 μm (1/e profile) for the 20× and 100× objectives, respectively. The absorbed laser energy in MoS$_2$ nanosheets will be conducted directly to the substrate via $R$ and to the in-plane direction, then to the substrate through the interface with effects from both $R$ and $D$. The same laser beam will excite the Raman signal of the sample, which can then be collected to analyze the temperature profile. By collecting and analyzing the Raman signals under different laser powers ($P$), we can obtain the Raman shift power coefficient (RSC): $\chi_{\text{Raman}} = \partial \omega / \partial P$. Two RSC values can be obtained for each sample by varying the objective objectives: $\chi_{\text{Raman}}$ for the 20× objective, $\chi_{\text{Raman}}$ for the 100× objective. Note that the temperature mentioned here is actually represented by RSC because we do not need to determine the absolute temperature increase when using the ET-Raman technique.

![Fig. 1](a) Schematic of MoS$_2$ under laser excitation (not to scale). In the MoS$_2$ sample, hot carriers are generated by photons (2.33 eV) while exciting electrons (e) to the conduction band ($E_c$), leaving holes (h) in the valence band ($E_v$). Through a fast thermalization process (~0.5 to 1.0 ps), hot carriers transfer part of the photon energy ($E - E_g$) to phonons, then diffuse out of the direct laser heating region to the low population region. Finally, they recombine with holes and lose their remaining photon energy ($E_g$) through phonon emission (carrier-phonon scattering). (b) An artistic representation of the experiment concept. A 532 nm continuous-wave (CW) or picosecond (ps) laser simultaneously heats and probes the temperature increase to generate four different energy transport states in space and time domains. (c) ps laser (pulse width is 13 ps, pulse period is 20.8 ns) heating under 100× and 50× objectives. No e−h recombination occurs within the short pulse time, and heat conduction from the heating region is negligible. The temperature increase is determined by the volumetric heat capacity ($c_v$) of the sample, with less effect from $(R, D)$ and $(D, D)$. (c) and (d) Two objective lenses (20× and 100×) of the CW laser are used to realize different laser spot sizes; heating with simultaneous Raman probing is used to detect the local temperature increase to study the $(R, D)$ effects. (c) Laser heating under the 20× objective. The radius of the laser spot size is around 1.50 μm (1/e profile). (d) The laser heating spot size is reduced using the 100× objective. The radius is around 0.366 μm (1/e profile).
Then, we generated two zero-transport states by applying a ps laser (532 nm, the pulse duration is 13 ps, the repetition rate is 48.2 MHz), as shown in Fig. 1(b). Similarly, we obtained RSC under both 50× and 100× objectives as \( x_{\text{ps1}} \) and \( x_{\text{ps2}} \), respectively. Within each pulse (13 ps), the thermal diffusion lengths for the MoS\(_2\) nanosheets and glass substrate were around 38 nm and 6.6 nm, respectively. \( (L_t = 2\sqrt{\alpha_k t_0}, \alpha_k = 2.75 \times 10^{-5} \text{ m}^2 \text{ s}^{-1} \) for MoS\(_2\) for the in-plane thermal diffusivity, and \( 8.26 \times 10^{-7} \text{ m}^2 \text{ s}^{-1} \) for glass\( ) \( t_0 = 13 \) ps is the ps laser pulse width). These are all much smaller than the laser spot size \( (r_0 \sim 0.246 \mu \text{m for the 100× objective and 0.431 \mu \text{m for the 50× objective})}. \) Hence, the heat conduction in the heating region has a very weak effect on the temperature increase. The relaxation time of the MoS\(_2\) nanosheets supported on a glass substrate \( (R \sim 10^{-6} \text{ K m}^2 \text{ W}^{-1}) \) can be estimated as \( \delta_1 \rho c_p R = 37.8 \) ns. When the thickness of MoS\(_2\) \( \delta_2 \) is 10 nm, its volumetric heat capacity \( \rho c_p = 1.89 \text{ MJ m}^{-3} \text{ K}^{-1} \); when the interface thermal resistance \( R \) is \( 2 \times 10^{-6} \text{ K m}^{-2} \text{ W}^{-1} \), the relaxation time is even longer than the ps laser cooling time \( (20.8 \text{ ns}) \). Therefore, the sample cannot be fully cooled to its original temperature. Instead, it is heated again when the next pulse comes until the sample reaches thermal equilibrium with the environment. Hence, there is a steady-state heat accumulation effect, as shown in Fig. 2(b). As a result, the temperature increase \( (x_{\text{ps}}) \) arises from the combined effects of a single pulse and the steady-state accumulation of heat. Especially, the effect of the heating amount on the steady-state accumulation is negligible. Therefore, the temperature increase induced by accumulation is almost identical under the same laser power level \( (e.g., 1 \text{ mW}) \) when thermal equilibrium is reached. However, the temperature increase from a single pulse mostly arises from the volumetric heat capacity of the sample \( (\rho c_p) \) and will be different for different heating sizes. By comparing the zero-conduction states under different heating sizes \( (100× \text{ and } 50× \text{ objectives}) \), we could eliminate the steady-state accumulation effect. As a result, we could use these zero-transport states \( (\text{ps laser heating}) \) to distinguish the roles of \( \rho c_p \) and \( (R, D) \) with a negligible contribution of \( D \) and \( R \) to the temperature increase.

For the MoS\(_2\) nanosheets on glass substrate, after the steady-state and zero-transport heating experiments, we defined the dimensionless normalized RSC as \( \Theta_1 = x_{\text{CW1}} / (x_{\text{ps2}} - x_{\text{ps1}}) \) and \( \Theta_2 = x_{\text{CW2}} / (x_{\text{ps2}} - x_{\text{ps1}}) \). Notably, this normalized RSC completely rules out the effects of laser absorption, Raman temperature coefficients, and the pulse accumulation effect. \( \Theta_1 \) and \( \Theta_2 \) are functions only of the 2D material and the \( \rho c_p, R, \) and \( D \) of the substrate materials. Using a 3D heat conduction model that includes all these properties, we could finally determine \( D \) and \( R \) of the 2D material. Consequently, using ET-Raman, the uncertainties from the evaluations of the absorbed laser power level and absolute temperature increase could be eliminated.

**Fig. 2.** (a) Schematic of the ET-Raman experiment setup. A typical MoS\(_2\)/glass sample is mounted on a 3D nano-stage and illuminated by CW and ps 532 nm lasers, which can be switched by the flip-mounted mirror. The same laser is used to excite the Raman signals, which are collected by a confocal Raman spectrometer (Voyage, BbW Tek, Inc.). The laser power is adjusted using a motorized ND filter. (b) The ps laser has a pulse width of around 13 ps, and the repetition rate is 48.2 MHz (cooling time is 20.8 ns). For our MoS\(_2\)-on-glass structure, the temperature cannot be cooled completely to the original temperature \( (T_0) \) before the next pulse comes. Therefore, there is a steady-state heat accumulation effect. (c) Compared with Si substrate, glass has a much smaller thermal conductivity \( (k \sim 1.4 \text{ W m}^{-1} \text{ K}^{-1}) \); therefore, its temperature cannot decay to its original state before the next pulse comes. (d) Raman spectra of MoS\(_2\) in an ambient air environment. The temperatures of MoS\(_2\) can be determined from the Raman spectra. \( E_{2g}^- \) \( (\sim 383 \text{ cm}^{-1}) \), \( A_{1g} \) \( (\sim 408 \text{ cm}^{-1}) \) modes were observed in our six samples. Here, we chose the \( E_{2g}^- \) mode to evaluate the MoS\(_2\) temperature profile.
Physical model and governing equations for data processing

For the steady-state heating, we used two partial differential equations to express the generation and diffusion of heat and electrical carriers in the sample in cylindrical coordinates:\(^{34,44}\)

\[
D \frac{1}{r} \frac{\partial}{\partial r} \left( r \frac{\partial N}{\partial r} \right) - \frac{\Delta N}{\tau} + \frac{\partial n}{\partial t} \Delta T_{\text{CW}} + \frac{\partial T_{\text{CW}}}{\partial t} + \Phi_a = 0, \tag{1}
\]

\[
k_{\parallel} \frac{1}{r} \frac{\partial}{\partial r} \left( r \frac{\partial T_{\text{CW}}}{\partial r} \right) + k_{\perp} \frac{\partial^2 T_{\text{CW}}}{\partial z^2} + \left( E_g - E_a \right) \Phi_a + E_a \Delta N \frac{\partial}{\partial t} = 0, \tag{2}
\]

where \(D\) (\(\text{cm}^2\;\text{s}^{-1}\)), \(\tau\) (s), \(\Delta T_{\text{CW}}(r,t)\) (K), and \(E_g\) (eV) are the carrier diffusion coefficient (diffusivity), the electron–hole recombination time, the temperature increase, and the bandgap energy of MoS\(_2\), respectively. \(k_{\parallel}\) (W m\(^{-1}\)K\(^{-1}\)) and \(k_{\perp}\) (W m\(^{-1}\)K\(^{-1}\)) are the in-plane and cross-plane thermal conductivity of few-layered MoS\(_2\), respectively. \(\Phi\) (photons per cm\(^2\) s) is the incident photon flux of the laser source, and \(\alpha\) is the optical absorption coefficient of the MoS\(_2\) nanosheets. \(n_0\) (cm\(^{-3}\)) is the equilibrium free-carrier density at temperature \(T\). In eqn (1), the first term on the left side describes the hot carrier diffusion. The second term \((\Delta N/\tau)\) represents the electron–hole recombination. The thermal activation term \((\partial n/\partial T_{\text{CW}})\Delta T_{\text{CW}}/\tau\) gives the carrier generation due to the temperature increase; it is negligible at a relatively low temperature increase and for a low free-carrier density.\(^{11,46,50}\) Term \(\Phi_a\) represents the carrier photogeneration source. In eqn (2), \(h\nu\) (2.33 eV) is the photon energy of the laser beam. The term \((E_g - E_a)\Phi_a\), which is proportional to \((E_g - E_a)\), represents the heat generation from the fast thermalization process. The last term, \(E_a \Delta N/\tau\), describes the heat generation through the non-radiative recombination of free carriers. In this work, the high ratio between the lateral size (7 to 16 \(\mu\text{m}\)) and thickness (sub 20 nm) of the MoS\(_2\) nanosheets allows us to only consider the hot carrier gradient in the in-plane direction.

The hot carrier diffusion can significantly extend the heated area, especially when the laser heating spot size (radius: 0.366 \(\mu\text{m}\) to 1.50 \(\mu\text{m}\)) is comparable to or smaller than the carrier diffusion length \((L_0 = \sqrt{\tau D}, \sim 0.1 \mu\text{m}\) for few-layered MoS\(_2\) (ref. 5 and 51)). Otherwise, the hot carrier diffusion will have a small or negligible effect on the heating area.

The zero-transport heating states only consider the fast thermalization process because the ps laser pulse (13 ps) is so short that we do not need to consider the hot carrier recombination process. Additionally, the hot electrons and holes will cool quickly (\(\sim 0.5\) to 1.0 ps), and the thermalization can be assumed to occur instantly in our process. As a result, for picosecond laser excitation, we can apply a single temperature to evaluate the fast thermalization process. By only considering the laser absorption in the MoS\(_2\) sample, we have

\[
\rho c_p \frac{\partial \Delta T_{\text{ps}}}{\partial t} = k_{\parallel} \frac{1}{r} \frac{\partial}{\partial r} \left( r \frac{\partial \Delta T_{\text{ps}}}{\partial r} \right) + k_{\perp} \frac{\partial^2 \Delta T_{\text{ps}}}{\partial z^2} + \alpha Q \frac{(h\nu - E_g)}{h\nu}, \tag{3}
\]

where \(Q\) (W cm\(^{-3}\)) is the peak laser intensity, \(t\) is the time, \(\Delta T_{\text{ps}}(r,t)\) represents the temperature increase in the zero-transport state. As discussed above, the temperature increase of the MoS\(_2\) nanosheets involves two states: steady-state accumulation of heat and a single pulse. For each sample, the temperature increases from the steady-state accumulation of heat are almost identical under the same laser energy level for both the 50\(\times\) and 100\(\times\) objectives. However, the temperature increase from each single pulse is different for the different heating sizes due to the difference in heat flux. By considering both space and time domain Gaussian distributions and the Beer–Lambert law, the laser intensity (heat flux) is given by:

\[
Q(r,z,t) = \frac{Q_0}{t_L} \exp \left( -\frac{r^2}{r_0^2} \right) \exp \left[ -\frac{\ln(2)t^2}{t_0^2} \right] \exp \left( -\frac{z}{t_L} \right), \tag{4}
\]

where \(Q_0\) (W cm\(^{-2}\)) is the peak laser intensity, \(r_0\) is the laser spot radius of the ps laser, and \(t_0\) (6.5 ps) is the half pulse width. \(t_L = \lambda/4\pi k_L = 38.5\) nm is the laser absorption depth for the MoS\(_2\) nanosheets. \(\lambda = 532\) nm (the laser wavelength), and \(k_L\) is the extinction coefficient. Thus, when comparing \(\Delta T_{\text{ps}}(50\times)\) and \(\Delta T_{\text{ps}}(100\times)\), \(\Delta T_{\text{ps}}(100\times) - \Delta T_{\text{ps}}(50\times)\) contains only the temperature difference from the single pulse.

In brief, under steady-state heating, the measured temperature increase of MoS\(_2\) is determined by the hot carrier diffusion coefficient and the thermal resistance of the interface. Under zero-transport state heating, the temperature increase difference for the two heating sizes \(\Delta T_{\text{ps}}(50\times)\) is only determined by the laser absorption and \(\rho c_p\). By solving eqn (1)–(4), we can rule out the laser absorption term and deduce the ratio of the temperature increase (the normalized RSC) \(T_{\text{CW}}/\left[T_{\text{ps}}(100\times) - T_{\text{ps}}(50\times)\right]\) of the sample from two heating states. Then, we can solve eqn (1) and (2) to analyze the experimental results and determine the hot carrier diffusivity and the interface thermal resistance. Note that the above governing equations consider both MoS\(_2\) and glass. The heat flow continues through the MoS\(_2\)/glass interface; however, the temperature is discontinuous because of the non-ideal contact. Therefore, their temperature difference was determined and used.

Fig. 2 shows a schematic of the Raman experiment setup (see ESI S1† for more details), which is the same as the one we used to study MoS\(_2\) nanosheets on c-Si substrates.\(^{31}\) In both the steady-state and zero-transport heating experiments, the laser beam is focused on a specific area of the samples (as shown in Fig. S1†). The temperature response of MoS\(_2\) can be evaluated by analyzing the Raman spectrum. Fig. 2(d) shows two prominent Raman peaks of MoS\(_2\): the in-plane (E\(_{2g}\)) mode located around 383 cm\(^{-1}\) and the out-of-plane (A\(_{1g}\)) mode located at around 408 cm\(^{-1} \).\(^{32}\)

In this work, we prepared six few-layered MoS\(_2\) samples supported on glass substrates using a micromechanical exfoliation technique (see ESI S2† for more details). Through AFM (atomic force microscopy) measurements, we determined the thicknesses of the six samples to be 1.8 nm, 3.0 nm, 5.4 nm, 7.8 nm, 11.4 nm, and 18 nm. To obtain a better idea of the uniformity of the surface structures of the samples, we also performed Raman shift mapping using a CW laser line for the 3.0 nm and 7.8 nm thick MoS\(_2\) samples (see ESI S2† for more
Thermal response of MoS$_2$ under CW and ps laser heating

For both steady-state and zero-transient state Raman experiments, eight room-temperature Raman spectra were collected at different laser powers by the control computer to determine the laser power coefficient for each sample. The CW laser energy was varied from 0.38 mW to 2.13 mW (0.090 to 0.506 MW cm$^{-2}$) under the 100× objective and from 1.34 to 7.59 mW (0.019 to 0.107 MW cm$^{-2}$) under the 20× objective. The ps laser energy was varied from 0.195 to 1.106 mW (pulse power density is 0.075 to 0.303 GW cm$^{-2}$) under the 50× objective and from 0.126 to 0.611 mW (pulse power density is 0.106 to 0.514 GW cm$^{-2}$) under the 100× objective. Note that this laser power represents the level just before the laser enters the surface of the MoS$_2$ sample; it is kept as low as possible to avoid heat-induced damage to the sample, which can also lead to broadening and shifting of the Raman peaks. Especially for ps laser Raman, photon absorption saturation must be avoided and the sample must be maintained within the linear temperature dependence range of its Raman properties. For the 532 nm picosecond pulse laser heating, the saturation intensity was around 1.13 GW cm$^{-2}$. When the photon density exceeds that level, the conductance band will be filled and the material will be unable to absorb further photons according to the Pauli exclusion principle. For the 1.8 nm thick MoS$_2$ under 100× objective with ps laser, we found that the saturation absorption began around 0.602 GW cm$^{-2}$, which is lower than the saturation intensity from the literature. Therefore, the saturation intensity for different samples may vary slightly, and very careful selection of the laser power range is necessary.

Next, we take the 1.8 nm thick sample to illustrate the results of this work. Fig. 3(a) shows five representative room temperature Raman spectra and their corresponding Lorentzian fits of MoS$_2$ under the 100× objective by CW laser. The results under the 50× objective by ps laser are shown in Fig. 3(b). In Fig. 3(a), with increasing laser power, both modes of MoS$_2$ shift linearly to the left (red shift); the shifts are visible as $\Delta v_0 = 0.38$ mW–2.13 mW) by CW laser and $\Delta v_0 = 0.19$ mW–1.11 mW) by ps laser for MoS$_2$. These Raman shift changes show that the temperature of the sample heating area increases under a higher laser power.

Note that the Raman linewidth of MoS$_2$ from the CW laser is smaller than that from the ps laser, as shown in Fig. 3(a) and (b). This is because the observed Raman signal is not solely dependent on the spectral resolution of the spectrometer, but is also dependent on the linewidth of the laser. The CW laser has a spectral linewidth of less than 0.01 pm. However, the picosecond laser has a linewidth of around 9 pm. However, this will not affect the absolute Raman peak position. Additionally, we used the linear fitting results from the Raman shift position against the laser power to determine the final results. Therefore, the absolute difference in Raman spectra from the two laser sources can be ruled out.

Different optical heating phenomena can be generated by applying two objective with the CW laser. In our specified laser power range for both the CW and ps lasers, the Raman shift linearly depends on the laser power by $\Delta v_0 = \alpha P_2$ for the first-order Raman shift power coefficient (RSC) for the two vibration modes of MoS$_2$, and $P$ (mW) is the laser power. Here, Raman results from this $E_{2g}$ vibration mode were chosen and used to deduce RSC considering the effects from the interlayer interactions and the effects of the substrate for $A_{1g}$ mode. Additionally, the effects of switching laser sources on the Raman results can also be eliminated by choosing $E_{2g}$ mode due to its weak polar dependence on the laser polarization configuration. Using the CW laser, as shown in Fig. 3(c) and (d), the linear fitting RSC result for MoS$_2$ $E_{2g}$ mode under the 20× objective ($\chi_{CW1}$) is $-(0.289 \pm 0.009)$ cm$^{-1}$ mW$^{-1}$, and that under the 100× objective ($\chi_{CW2}$) is $-(0.960 \pm 0.043)$ cm$^{-1}$ mW$^{-1}$. $\chi_{CW2}$ is larger than $\chi_{CW1}$ because the temperature increases more rapidly under the 100× objective due to its larger power density (smaller laser spot size). Additionally, these values are much higher than the corresponding RSC (CW) values of MoS$_2$ (6.6 nm thick) on c-Si substrate: $-0.026$ cm$^{-1}$ mW$^{-1}$ (20× objective) and $-0.150$ cm$^{-1}$ mW$^{-1}$ (100× objective). For the glass substrate, the heat dissipation is less efficient due to its low thermal conductivity. Therefore, a larger temperature increase is expected for MoS$_2$ supported on glass substrate. Using the ps laser under the 50× and 100× objectives, as shown in Fig. 3(e) and (f), the RSC values of MoS$_2$ in $E_{2g}$ mode are $-(1.85 \pm 0.11)$ cm$^{-1}$ mW$^{-1}$ and $-(3.77 \pm 0.08)$ cm$^{-1}$ mW$^{-1}$, respectively. The power coefficient under the 100× objective ($\chi_{ps1}$) is larger than that under the 50× objective ($\chi_{ps2}$). This difference arises from the temperature increase from a single pulse. As with CW laser heating, the ps laser under the 100× objective has a higher power density. Similarly, for the 50× objective, the RSC (ps) value is also much higher than the corresponding value of MoS$_2$ (6.6 nm thick) on c-Si substrate ($-0.057$ cm$^{-1}$ mW$^{-1}$). We also summarized the RSC values for all six samples in Table S1 (see ESI S3†). The RSC roughly increases with the sample thickness for both CW and ps laser heating. When the sample thickness is smaller than its laser absorption depth, the thicker sample will absorb more energy and a higher temperature increase is expected. As a result, the Raman wavenumber change will increase under the same laser power level.

Determination of $D$ and $R$

We applied 3D numerical modeling based on the finite volume method to calculate the temperature increase to determine the $D$ and $R$ values. Detailed information for the modeling is provided in the experimental section. Taking 1.8 nm thick MoS$_2$ as an example, from the 3D numerical simulation and Raman experiment, we can calculate the normalized RSC values ($\theta_1$,
and $\theta_3$ for MoS$_2$ in the $(D, R)$ space. Fig. 4(a) and (b) show the calculated normalized RSC mapping for MoS$_2$. Many different $(D, R)$ pairs can satisfy the experimental normalized RSC (the isolines). By combining the results from these two cases, as shown in Fig. 4(c), we can determine the exact $D$ and $R$ values from the cross point of the blue ($\theta_1$) and dark red ($\theta_2$) dashed curves: $D$ is $4.17$ cm$^2$ s$^{-1}$, and $R$ is $1.28 \times 10^{-6}$ K m$^2$ W$^{-1}$. The normalized probability distribution function ($\Omega$) is used to present the uncertainty of the final result, as shown in the false color map of Fig. 4(c). $\Omega = \exp[-(x-x_0)^2/(2\sigma^2)]$, where $x$, $x_0$, and $\sigma$ are the variable, its average, and the standard deviation, respectively. In the $(D, R)$ space, we have $\Omega_{(D,R)} = \Omega_0 Q_0 \theta_2$. We used the value of $\Omega_{(D,R)} = 0.6065$ corresponding to the $\sigma$ confidence in the $(D, R)$ space to evaluate the uncertainty of the final results. Finally, the deduced $R$ is $1.28^{+0.16}_{-0.16} \times 10^{-6}$ K m$^2$ W$^{-1}$, and $D$ is $4.17^{+1.11}_{-0.97}$ cm$^2$ s$^{-1}$. The final results with the uncertainties for all six samples are summarized in Table 1 and are also plotted in Fig. 5(a) and (b).

Then, we obtained the temperature profile from the 3D modeling (by the determined $D$ and $R$) for the 1.8 nm thick MoS$_2$ sample and its substrate under the $20 \times$ (left part) and $100 \times$ (right part) objectives with CW laser heating. As shown in Fig. 4(d), this visualizes the effects of hot carrier diffusion on the thermal energy distribution. The temperature increase is quite uniform with increasing thickness due to the large lateral/vertical size ratio of the MoS$_2$ nanosheets. Especially, the temperature increase in glass results from the thermal energy transferred from the upper MoS$_2$. The low thermal conductivity of glass restricts the heat dissipation. Compared with the laser energy distribution (dark curve), the temperature distribution of MoS$_2$ is far outside the laser spot, especially for the small heating size ($100 \times$ objective). This is because the diffusion length $L_D$ (646 nm for 1.8 nm thick MoS$_2$) is $1/2$ of $r_0$ under the $20 \times$ objective (1.5 $\mu$m) and almost twice that size under the $100 \times$ objective (366 nm). Therefore, the effect of hot carrier diffusion on heat conduction is more prominent under the $100 \times$ objective. To model the zero-transport state ps laser...
heating, we only considered the temperature increase from the single pulse. As shown in Fig. 4(e), the temperature increase of MoS2 has almost the same distribution as the ps laser energy. This confirms that $R$ and $D$ have negligible effects on the temperature increase of the samples. The temperature increase of the glass substrate is close to zero due to negligible heat transport from MoS2 during the very short ps laser pulse duration.

During the diffusion process of the carriers, electrons (e) and holes (h) move as units because of Coulomb attraction. Additionally, in this optical study, equal numbers of electrons and holes were generated, and their effective masses were comparable and even similar. Therefore, the measured value $D$ can be treated as the unipolar carrier diffusion of both electrons and holes. Additionally, the diffusion is related to the mobility ($\mu$) by the Einstein relation in this thermalized system, $D/k_B T = \frac{\mu^2}{e}$

### Table 1
Summary of the interface thermal resistance ($R$) and hot carrier diffusion coefficient ($D$) values from the 3D numerical modeling and data fitting, with the corresponding electron mobilities ($\mu$) and hot carrier diffusion lengths ($L_D$)

<table>
<thead>
<tr>
<th>Sample thickness (nm)</th>
<th>$D$ (cm$^2$ s$^{-1}$)</th>
<th>$\mu$ (cm$^2$ V$^{-1}$ s$^{-1}$)</th>
<th>$L_D$ (nm)</th>
<th>$R$ (10$^{-6}$ K m$^2$ W$^{-1}$)</th>
</tr>
</thead>
<tbody>
<tr>
<td>1.8</td>
<td>$4.17 \pm 0.33$</td>
<td>$166.8 \pm 39.1$</td>
<td>$645.8 \pm 365.1$</td>
<td>$1.28 \pm 0.16$</td>
</tr>
<tr>
<td>3.0</td>
<td>$9.71 \pm 1.89$</td>
<td>$388.5 \pm 62.8$</td>
<td>$985.5 \pm 414.4$</td>
<td>$1.84 \pm 0.17$</td>
</tr>
<tr>
<td>5.4</td>
<td>$5.17 \pm 0.70$</td>
<td>$206.8 \pm 38.0$</td>
<td>$719.0 \pm 264.7$</td>
<td>$1.94 \pm 0.15$</td>
</tr>
<tr>
<td>7.8</td>
<td>$2.33 \pm 0.20$</td>
<td>$133.6 \pm 23.1$</td>
<td>$482.9 \pm 122.9$</td>
<td>$1.16 \pm 0.15$</td>
</tr>
<tr>
<td>11.4</td>
<td>$0.76 \pm 0.32$</td>
<td>$30.2 \pm 15.6$</td>
<td>$274.9 \pm 185.2$</td>
<td>$7.09 \pm 0.14$</td>
</tr>
<tr>
<td>18.0</td>
<td>$0.78 \pm 0.25$</td>
<td>$31.0 \pm 15.2$</td>
<td>$278.5 \pm 194.8$</td>
<td>$0.41 \pm 0.14$</td>
</tr>
</tbody>
</table>

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\[ \mu/q, \] where \( k_B \), \( T \), and \( q \) are the Boltzmann constant, temperature, and the amount of charge of each carrier. Here, we assume that the carriers have a thermal distribution of 300 K during the diffusion process due to the ultra-short energy relaxation process (only several picoseconds). As a result, our measured \( D \) corresponds to a mobility range from 31.0 cm\(^2\) V\(^{-1}\) s\(^{-1}\) (18.0 nm thick) to 388.5 cm\(^2\) V\(^{-1}\) s\(^{-1}\) (3.0 nm thick). Carrier mobilities of 30 to 60 cm\(^2\) V\(^{-1}\) s\(^{-1}\) for few-layered MoS\(_2\) on SiO\(_2\) (ref. 39) and \(-70\) cm\(^2\) V\(^{-1}\) s\(^{-1}\) for few-layered MoS\(_2\) on Al\(_2\)O\(_3\) (ref. 59) were reported previously; these values are in excellent agreement with our lower bound measurement results. Our upper bound measurements are larger than those in most reported work. We attribute this to the fact that our MoS\(_2\) samples are unprocessed and unconstrained. Early electrical measurements deduced motilities in the range of 100 to 260 cm\(^2\) V\(^{-1}\) s\(^{-1}\) for bulk MoS\(_2\) crystals. Moreover, the theoretical optical-phonon-scattering-limited mobility was reported up to 400 cm\(^2\) V\(^{-1}\) s\(^{-1}\) by adopting high-\( \kappa \) dielectric materials (e.g., HfO\(_2\), Al\(_2\)O\(_3\)) to build top-gated devices.\(^{5,7,19,60}\) Furthermore, compared with the c-Si substrate (p-doped) we used in our previous work,\(^{41}\) the insulator glass substrate used in this work can create a better dielectric environment to enhance the dielectric screening of Coulomb potentials, which can lead to enhanced carrier mobility, especially for relatively thin MoS\(_2\) samples.\(^{39,40}\) Additionally, compared to air (dielectric constant is 1), MoS\(_2\) has a much larger dielectric constant (\(-4\)).\(^{41}\) As a result, for thicker MoS\(_2\) samples, the upper part itself can also serve as a high dielectric environment (dielectric capping effect).\(^{39}\)

**Effects of MoS\(_2\) thickness on \( R \) and \( D \)**

To determine the effects of the MoS\(_2\) thickness on the interface energy coupling and hot carrier transport, we plotted them as a function of MoS\(_2\) thickness, as shown in Fig. 5. For comparison, the \( D \) and \( R \) results from MoS\(_2\) supported on c-Si substrate from our previous work are also plotted in these two figures. Table 1 also lists all the results. The uncertainties of \( R \) and \( D \) mainly arise from the RSC fitting procedure. For the hot carrier diffusion coefficient \( D \), as shown in Fig. 5(a), the 3.0 nm MoS\(_2\) sample has the largest value. Similar trends for this thickness-dependent carrier mobility were reported previously.\(^{40,62}\) The inset of Fig. 5(a) shows the carrier mobility results from Lin et al.’s work.\(^{62}\) They attribute their results to the effects of the metal source/drain contacts; only the top MoS\(_2\) layer could be connected to the contacts in their work.\(^{44}\) With decreasing sample thickness, the absence of sufficient screening of the substrate results in lower mobility. However, when the thickness decreases, the finite interlayer conductivity (in a resistor network model) can result in an effective higher total mobility.\(^{44}\)

The competition of these two physical aspects accounts for the maximum mobility value at a certain layer thickness.\(^{44}\) For our optically generated hot carrier transport, the resistor network model does not apply. Instead, we provide the following explanations for this nonmonotonic relationship between the sample thickness and hot carrier diffusivity. For thin samples (1.8 nm and 3.0 nm thick), with increasing film thickness, the effect of the charge impurities decreases and the screening of the substrate increases, both leading to enhanced carrier transport.\(^{44}\) During the sample transfer process, contamination of the sample cannot be avoided. This contamination includes charged impurities and defects such as absorbed or trapped oxygen and water, residue from gel film or Scotch tape, or trapped ions and substrate defects.\(^{62}\) All these can significantly contribute to disorders and degrade the hot carrier transport. For thicker samples, as shown in the sample AFM characterization results in the ESI,\(^{†}\) the white dots in the AFM images can be the high points of the gel film residues, especially for the thick samples (> 7.8 nm thick). The loose contact caused by the high points of the substrate can weaken the dielectric screening of the substrate and restrict the carrier transport. This also accounts for the fact that, as shown in Fig. 5(a), the \( D \) values for the thicker MoS\(_2\) samples are almost at the same level for both
the glass and c-Si substrates. However, the measured \( D \) in this work is relatively lower. As discussed in the sample preparation section in the ESI,\(^\dagger\) the hydrophilic glass dielectric surface can introduce more water molecules to thicker MoS\(_2\) nanosheet samples. These water molecule-induced electronic traps can also affect the charge transfer, leading to decreased carrier diffusivity.\(^6\) Additionally, for the maximum \( D \) value (3.0 nm thick MoS\(_2\)), further discussion can be found in the next section.

For the interface thermal resistance, as shown in Fig. 5(b), the values we obtained here are on the order of 2 \( \times 10^{-7} \) K m\(^2\) W\(^{-1}\). These are much larger than those found in our previous work for c-Si supported MoS\(_2\) nanosheets [dark dots in Fig. 5(b)], such as \( R \) of 1.75 \( \times 10^{-7} \) K m\(^2\) W\(^{-1}\) for 6.6 nm MoS\(_2\).\(^3\)

On the one hand, the ET-Raman method eliminates errors from the laser absorption evaluation and temperature coefficient calibration. Therefore, we do not need to consider those two factors. On another hand, as we mentioned in the introduction, the glass substrate we used in this work was not polished, unlike the c-Si substrate. Therefore, the MoS\(_2\) nanosheets prepared by mechanical exfoliation onto glass substrates are actually supported by the high points of the substrate. This imperfect and loose interface contact can dramatically weaken the interface energy coupling.\(^6\) Additionally, as shown in Fig. 5(b) and S1(e),\(^\dagger\) the 11.4 nm thick MoS\(_2\) sample has both the largest \( R \) value and largest lateral size. It is possible that the stress in the exfoliated MoS\(_2\) samples is difficult to release, especially for the samples with large lateral sizes. This type of stress can also decrease the interface energy coupling. In this work, the dielectric substrate enhances the screening and simplifies the transfer of hot carriers. There are some concerns regarding the applicability of ET-Raman to study the hot carrier mobility of 2D MoS\(_2\) supported on metal surfaces. With metal as the substrate, Fermi level pinning (FLP) will occur at the interface; thus, the Fermi level will be pinned closer to the conduction band in MoS\(_2\). This Fermi level shift may form covalent bonds between MoS\(_2\) and the contact metal. As a result, most of the photo-generated charge carriers will diffuse into the metal substrate. Additionally, many other complicated physical phenomena must be taken into consideration when using a metal substrate, such as enhanced surface recombination and low substrate Coulomb screening. In this case, it is very difficult to use ET-Raman to study the effects of heating size variation.

### Theoretical Raman intensity study

The theoretical Raman intensities of different samples can be evaluated by considering multiple reflections of both the incident laser beam and the Raman signal within the supported MoS\(_2\) nanosheets. A comparison of the theoretical Raman intensities \( F \) and the experimental Raman intensities is shown in Fig. 5(c). As has been studied in our previous work, the Raman signal of the sample will be significantly enhanced if there is even a very small spacing at the interface (MoS\(_2\) supported on c-Si substrate). In the experiments, the 3 nm thick sample showed the largest Raman intensity per unit of laser power excitation. Moreover, we attempted to increase the interface spacing level (from 0 to hundreds of nanometers) and found that the theoretical Raman intensity was not very sensitive to spacing (increased by only less than 10\%) for our samples. This shows that the spacing has a very limited contribution to this Raman intensity enhancement.

Additionally, as shown in Fig. 5(a) and (c), the theoretical Raman intensity showed the same change trend we found for the \( D \) value versus sample thickness. This can be explained as follows. MoS\(_2\) is experimentally considered to be an n-type semiconductor due to its sulfur vacancies.\(^6\)\(^,\)\(^9\) This means that the donor (electron) concentration is larger; however, it may vary between samples. This difference endows MoS\(_2\) with slightly different Fermi energy levels, and the Fermi energy increases (shifts to the conduction band) with increased electron concentration. Additionally, because the electron-phonon scattering rate and Fermi energy have a positive correlation, the Raman intensity is inversely proportional to the Fermi energy.\(^7\)\(^,\)\(^8\) In the Raman laser heating process, the 3.0 nm thick sample has the largest carrier diffusivity, which can result in a lower carrier concentration level in its excitation region due to the fast carrier diffusion. This will lead to a relatively lower Fermi energy level. Therefore, the local Raman intensity is enhanced and is much greater than the theoretical intensity.

For the experimentally obtained Raman intensities, we used a 50 \( \times \) objective lens (NA = 0.5) to collect the Raman signals for all six samples under the same laser energy level (2.5 mW before entering the sample) and with the same integration time (4 s). Moreover, we assumed the normal incidence because of the backscattering geometry; the propagation direction of the incident and scattered light is perpendicular to the plane of the MoS\(_2\). Also, the laser beam is Gaussian, and the focused laser beam hits the sample surface at the beam waist, which provides the normal incidence of the laser beam in the sample.\(^7\)\(^,\)\(^8\) For our MoS\(_2\) samples, the thickness is too small to consider the portion of the beam entering the sample at an oblique angle.

### Heat accumulation effect

As discussed in the physical model, for a glass substrate-supported MoS\(_2\) sample under pulsed laser heating, we must consider the effects of heat accumulation. Based on the thermal diffusion length (~262 nm) in glass within one repetition period, the sample will cool to around 3\% of its original value before the subsequent pulse comes. As a result, the energy absorbed at the focal volume from each pulse has no time to diffuse out before the next pulse, thus forming a point source of heat.

The temperature increase measured by Raman spectroscopy in ps laser heating arises from two sources: single pulse heating and steady-state accumulation heating. Due to the different heating sizes from the 100\( \times \) and 50\( \times \) objectives, the temperature increase from a single pulse is different. During the first several rounds of pulse heating, the temperature increases from steady-state accumulation at the 100\( \times \) and 50\( \times \) objectives are also different due to the heating size effect. However, with longtime heating under same power level (1 mW), this difference will disappear. Within one heating period (20.8 ns), the
thermal diffusion length \( (L_t) \) of MoS\(_2\) is 1.513 \( \mu \)m (lateral direction) \( (L_c = 2\sqrt{\alpha_0 e_t}, \ t_c = 20.8 \text{ ns}) \). Also, hot carrier diffusion can increase the heating size. The minimum hot carrier diffusion length is 0.275 \( \mu \)m (11.4 nm thick sample, from Table 1). Consequently, considering the original laser heating size, thermal diffusion and hot carrier diffusion, the heating sizes at the end of each heating period expand to around 2.034 \( \mu \)m and 2.219 \( \mu \)m for the 100 \( \times \) and 50 \( \times \) objectives, respectively. The less than 10% difference in heating size will fade and diminish when thermal equilibrium is reached. Therefore, we can conclude that the measured temperature increases \( (T_e) \) from steady-state accumulation at 100 \( \times \) and 50 \( \times \) have a negligible difference.

**Conclusion**

Taking advantage of the ET-Raman technique without laser absorption or absolute temperature evaluation, we successfully determined the interface thermal resistances \( (R) \) and hot carrier diffusivities \( (D) \) of six mechanically exfoliated MoS\(_2\) nanosheets supported on glass substrates. The sample thickness spanned one order of magnitude: 1.8 to 18 nm. This special structure provides one-side normal-\( \alpha \) dielectric screening and very little material damage, unlike that which occurs in the top dielectric material coating in traditional mobility measurements. Compared with highly polished c-Si substrate, the glass substrate induced a relatively high interface thermal resistance: 0.41 to 7.09 \( \times \) 10\(^{-6}\) K m\(^2\) W\(^{-1}\), about one order of magnitude higher than that of the MoS\(_2\)/c-Si interface. The determined \( D \) values span 0.76 to 9.7 cm\(^2\) s\(^{-1}\), corresponding to a mobility range of 30.2 to 388.5 cm\(^2\) V\(^{-1}\) s\(^{-1}\). A nonmonotonic thickness-dependent \( D \) trend was discovered and was attributed to the decreased charge impurities in the thin samples and loose contact with the substrate or possible wet substrate surfaces for the thicker samples. The very high hot carrier mobility decreases the hot carrier concentration in the laser heating region in Raman experiments, leading to decreased electron-phonon scattering and enhanced Raman intensity. This has been confirmed by our Raman intensity study and by comparison with theoretical predictions.

**Conflicts of interest**

The authors declare no competing financial interest.

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